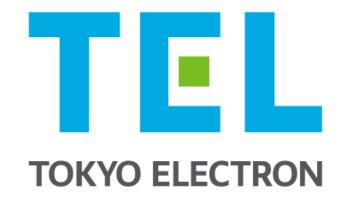
The 62nd Annual General Meeting of Shareholders



June 17, 2025



FY2025 Financial Report

(FY2025 : April 1, 2024 - March 31, 2025)

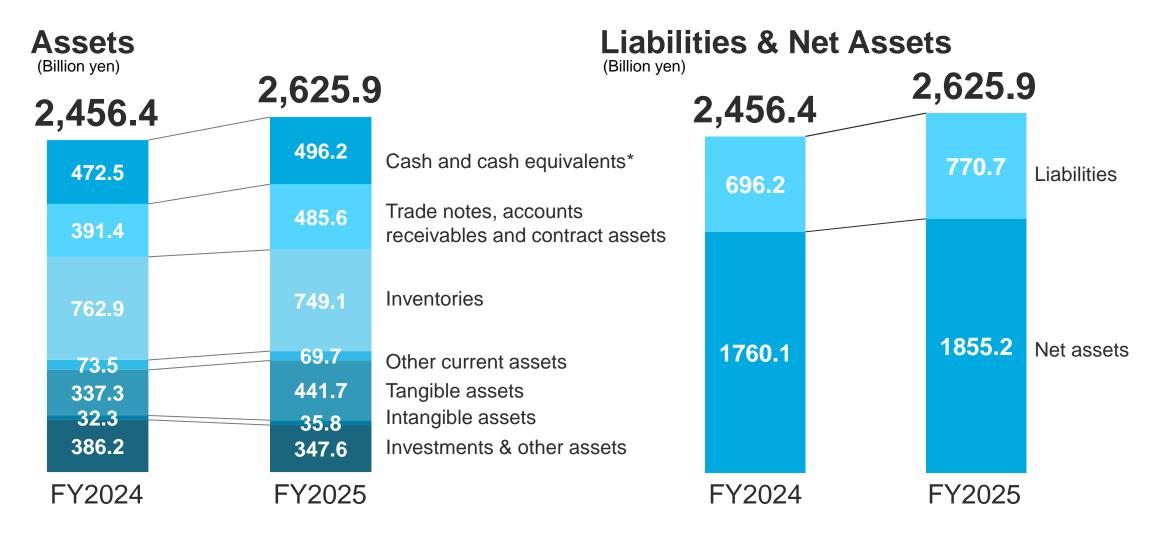


Consolidated Statement of Income

(Billion yen)

	FY2024	(%)	FY2025	(%)	Variance
Net sales	1,830.5	100.0	2,431.5	100.0	+33%
Gross profit	830.2	45.4	1,146.2	47.1	+38%
Operating income	456.2	24.9	697.3	28.7	+53%
Ordinary income	463.1	25.3	707.7	29.1	+53%
Income before income taxes	473.4	25.9	706.1	29.0	+49%
Net income attributable to owners of parent	363.9	19.9	544.1	22.4	+50%
EDS (von)	784		1,182		+51%
EPS (yen)	704		1,102		+31%
ROE	21.8%		30.3%		+8.5pts

Consolidated Balance Sheet



^{*}Includes time deposits + short-term investments (indicated as securities on the balance sheet)



Non-consolidated Financial Statement

Statement of Income _____ (Billion yen)

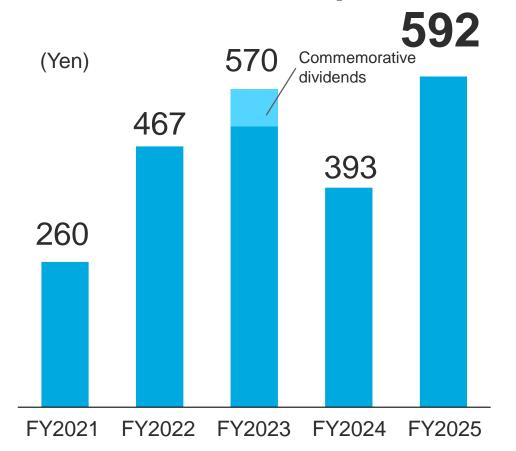
	FY2024	(%)	FY2025	(%)	Variance
Net sales	1,625.2	100.0	2,204.0	100.0	+578.8
Gross profit	537.3	33.1	665.0	30.2	+127.7
Operating income	401.7	24.7	506.2	23.0	+104.4
Ordinary income	441.3	27.2	550.2	25.0	+108.8
Income before income taxes	441.3	27.2	549.4	24.9	+108.1
Net income	340.1	20.9	424.8	19.3	+84.6

Balance Sheet

	FY2024	(%)	FY2025	(%)	Variance
Total assets	1,860.8	100.0	1,875.5	100.0	+14.6
Total liabilities	661.4	35.5	687.2	36.6	+25.8
Total net assets	1,199.3	64.5	1,188.2	63.4	△11.1
Total liabilities & net assets	1,860.8	100.0	1,875.5	100.0	+14.6

FY2025 Dividend

[Annual dividend per share]



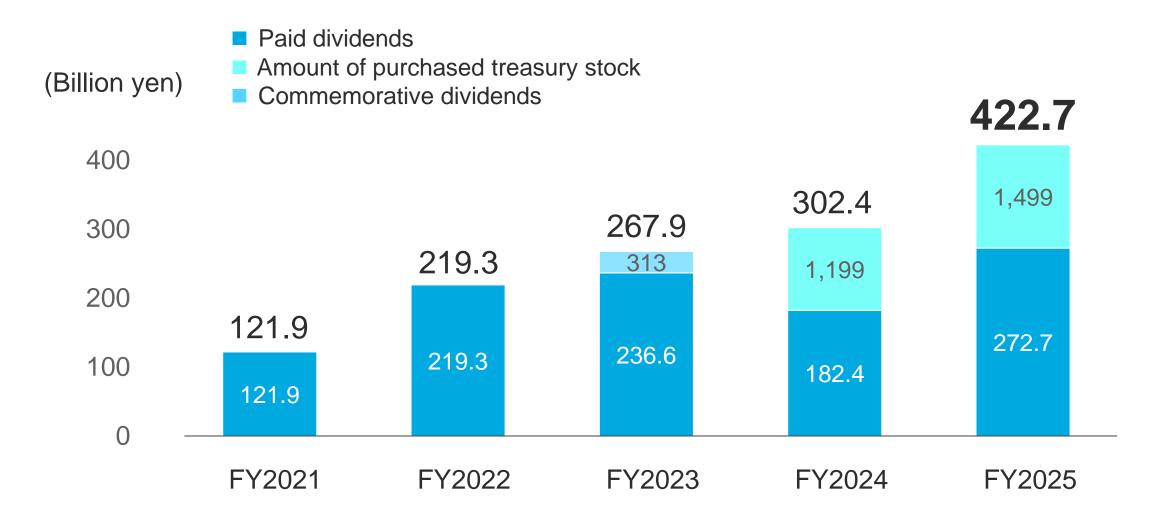
Interim	Year-end	Annual dividend
265 yen	327 yen	592 yen

Total dividend	Payout ratio
272.7 billion yen	50.1%

Note: The per share dividend amounts for FY2020 to FY2023 are stated based on the assumption of a stock split at the beginning of FY2020.



FY2025 Total Return Amount



FY2026 Financial Estimates

(FY2026 : April 1, 2025 – March 31, 2026)



Current Business Environment (This year's WFE Market Outlook)

Forecasting flat market size YoY

- Lull in both automotive and power semiconductor investment,
 and investment by emerging Chinese manufacturers
- Expect continued and significant demand for AI servers
 - Driving investment in leading-edge logic (2nm) and HBM*
- Geopolitical trends should be closely monitored

* High Bandwidth Memory



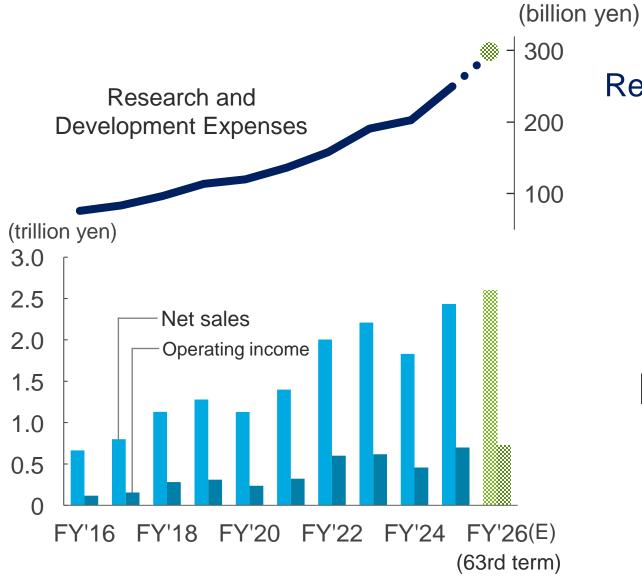
FY2025 Consolidated Financial Estimate

(Billion yen)

	1 st half	2 nd half	Full year
Net sales	1,150.0	1,450.0	2,600.0
Gross profit	527.0 45.8%	701.0 48.3%	1,228.0 47.2%
Operating income	288.0 25.0%	439.0 30.3%	727.0 28.0%
Ordinary income	293.0	443.0	736.0
Income before income taxes	293.0	443.0	736.0
Net income	224.0	342.0	566.0

Expect record high profits for the second consecutive fiscal year

Continuous R&D investment



Research and Development Investment

300 billion yen (63rd term)

Maximizing the potential for future growth

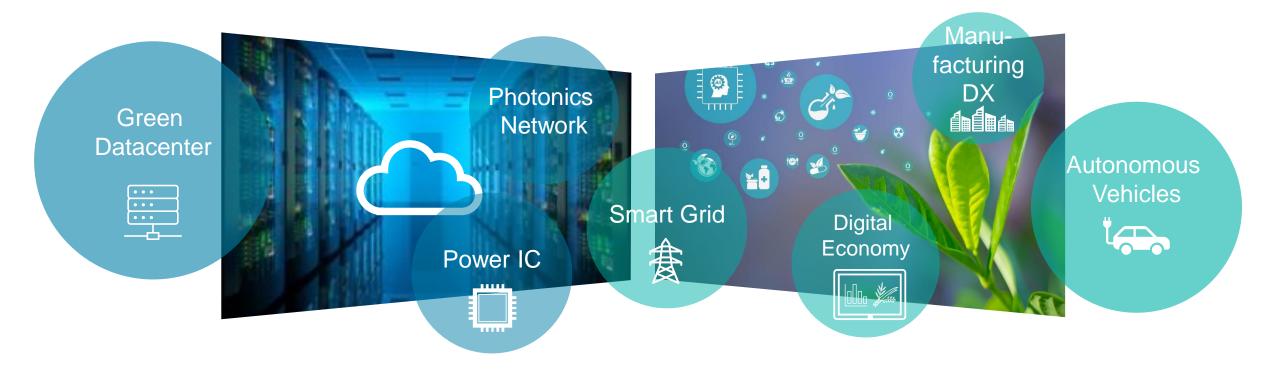
Aiming for Medium- to Long-term Profit and Continuous Corporate Value Enhancement

- 1. Business Environment
- 2. The Medium-term Management Plan
- 3. Aiming for Further Corporate Value Enhancement
- 4. Returns to Shareholders

1. Business Environment



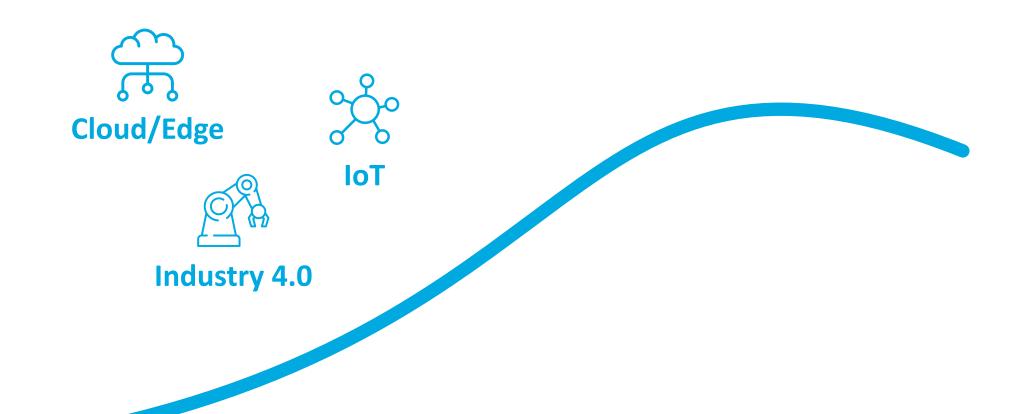
Digital X Green



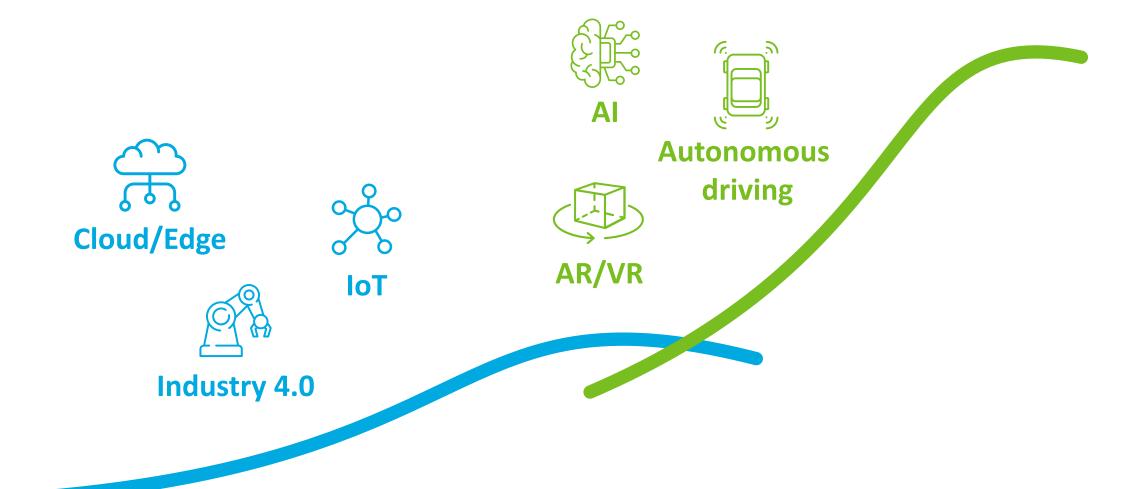
"Green by Digital" & "Green of Digital"

History of Tokyo Electron





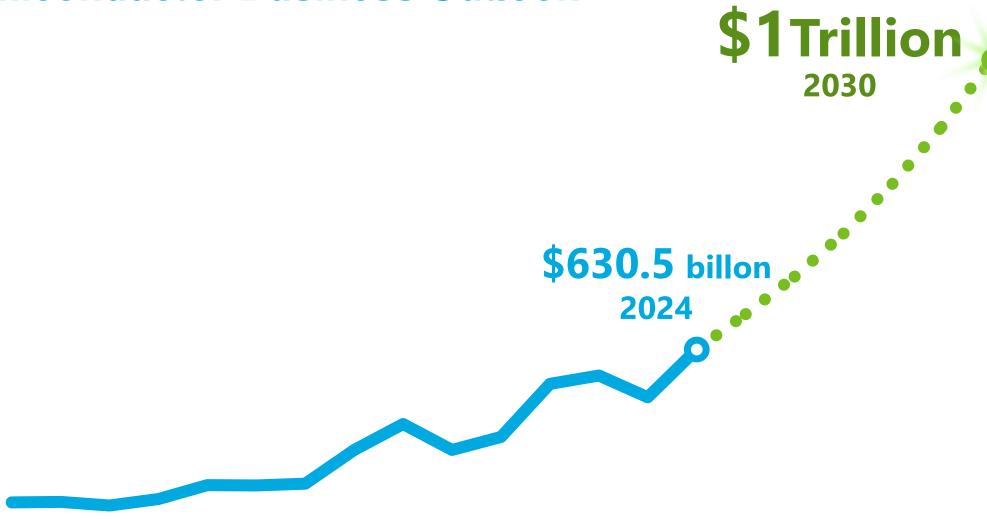
1st Wave



1st Wave

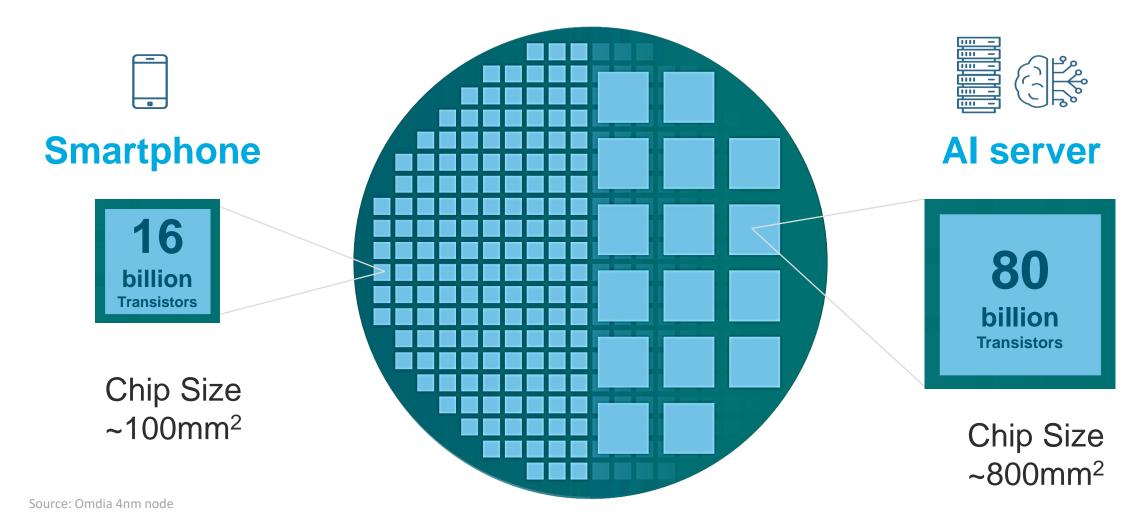
2nd Wave

Source: SEMI 2024





Advanced Semiconductors Indispensable for AI Servers

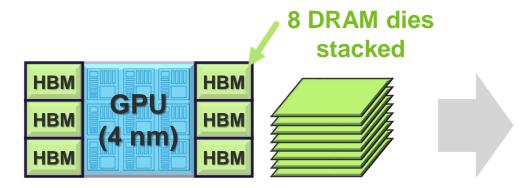


Advanced Semiconductors Indispensable for AI Servers

TEL estimate



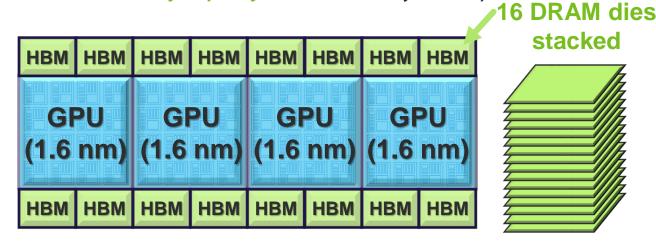
Memory Capacity 141 GB



GPU: Graphic Processing Unit HBM: High Bandwidth Memory

1.6 nm Generation as of 2028 ~640 billion transistors

Memory Capacity 1TB (1,024GB)



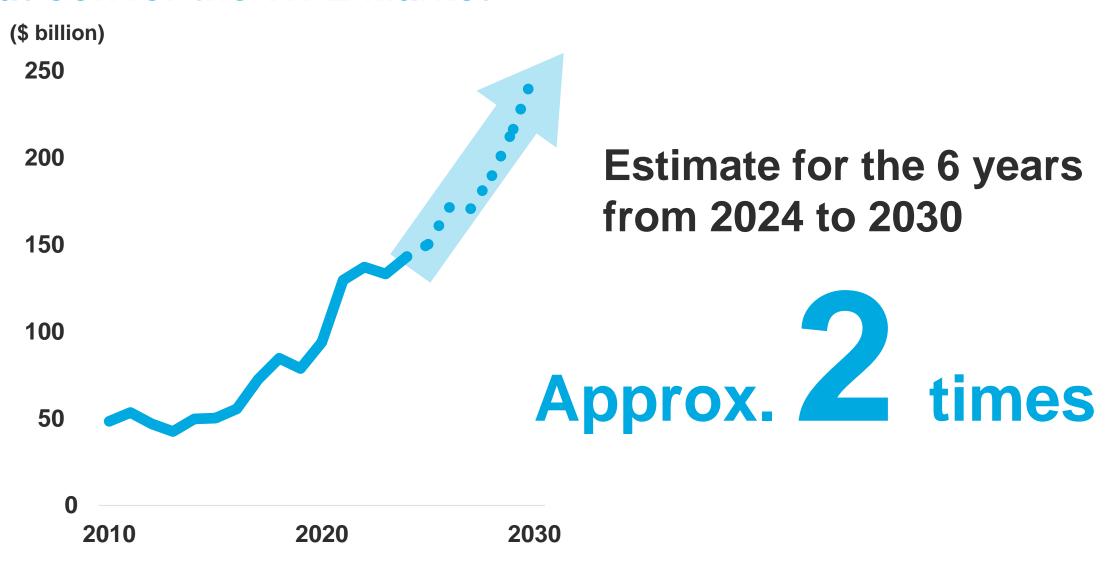
Scaling and integration of transistors, as well as increasing capacity of HBM, are progressing

Technological Innovation of Semiconductors Never Stops

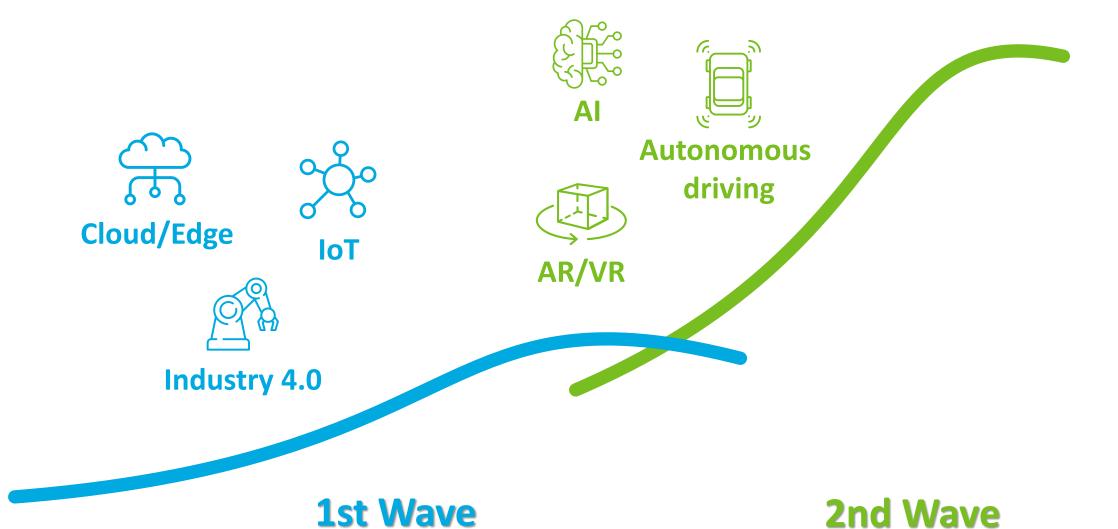


Pursue higher speed, larger capacity, superior reliability, and lower power consumption

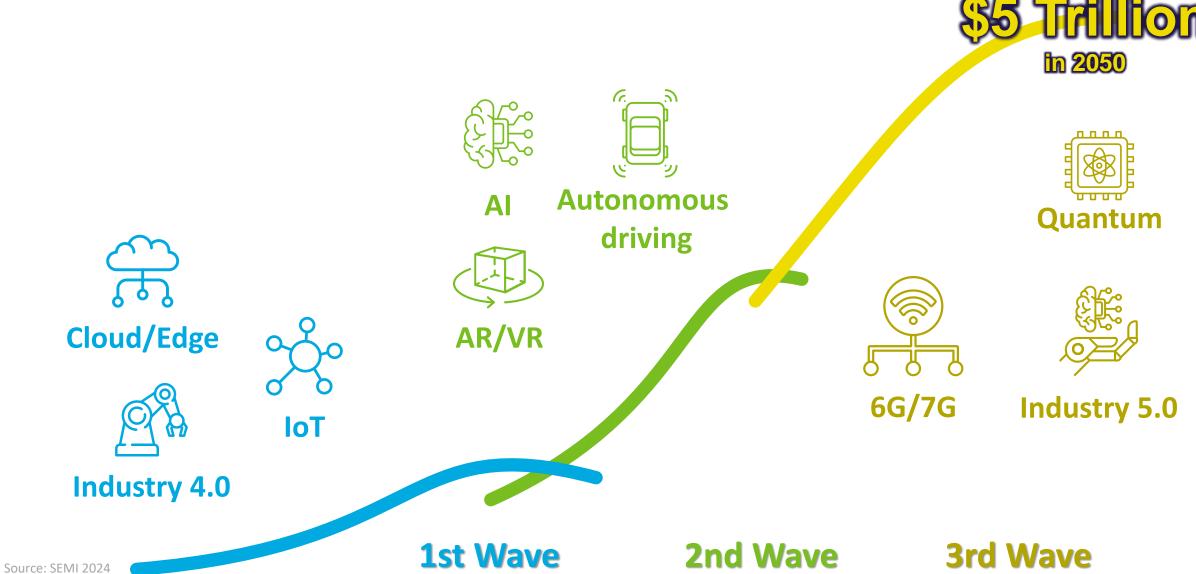
Outlook for the WFE Market



Source: TechInsights (April, 2025)



Source: SEMI 2024

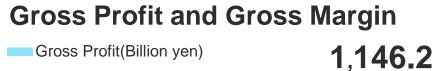


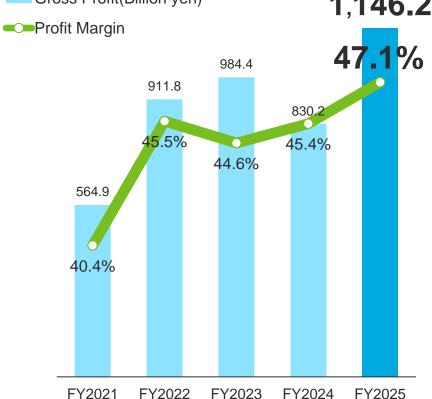
2. The Medium-term Management Plan

The Medium-term Management Plan: Financial Targets (Announced in June 2022)

Financial Targets (by FY2027)		
Net sales	≥ 3 trillion yen	
OP margin	≥ 35%	
ROE	≥ 30%	

Progress of Medium-Term Management Plan Initiatives





YoY Market Share Growth Highlights for 2024



FY2025 Sales Highlights

Wafer Bonder 3 times in 2 years



Gartner

1 Charts/graphics created by TEL based on Gartner research. Calculations performed by TEL Source: Gartner®, "Market Share: Semiconductor Walfer Fab Equipment, Worldwide, 2024", Bob Johnson, Menglin Cao, 21 April 2025, Revenue from Shipments basis. [Locater/Developer: Photoresist Processing Transcop, Intelligent Processing Transc

Our competitiveness has continuously grown

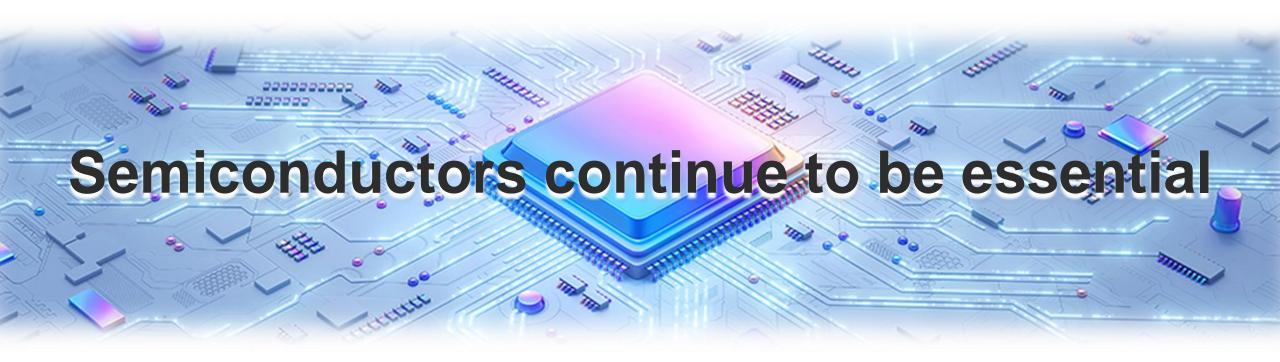
Risks in the Business Environment





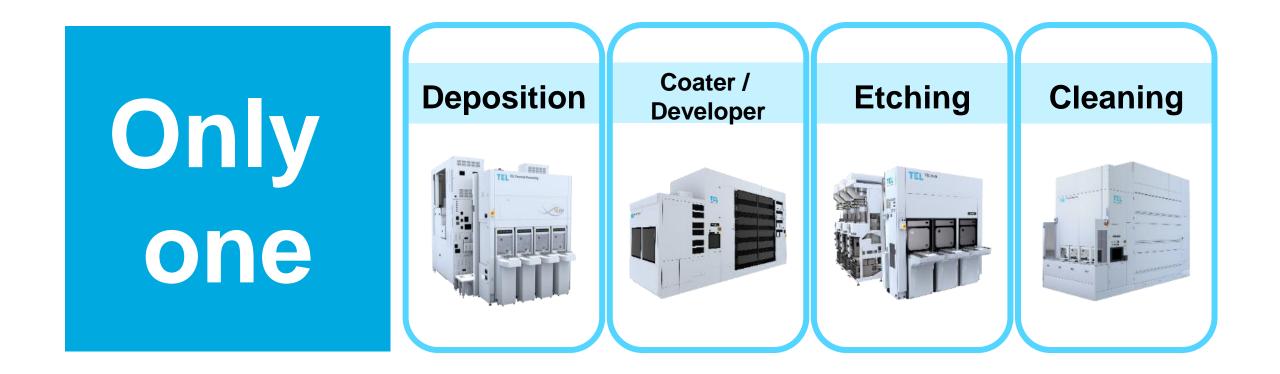






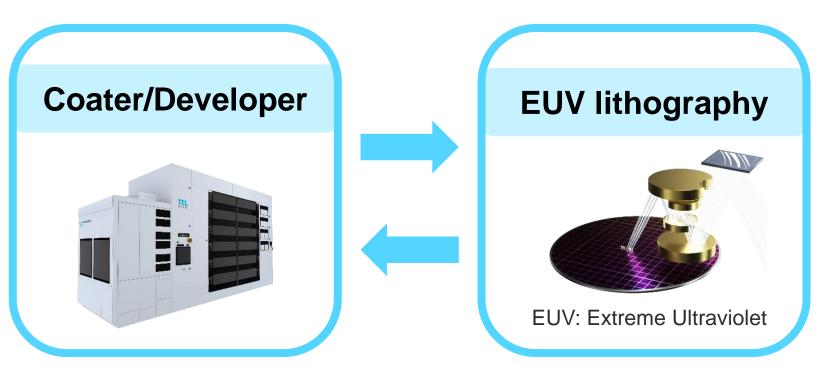
Further improving core competence





Have products in 4 sequential processes





100% share of coater/developer for EUV lithography

*TEL estimate



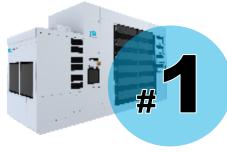
TEL Estimate

Coater / Developer

Cleaning

Plasma Etch

Gas Chemical Etch







Diffusion Furnace Batch Deposition

Metal Deposition

Prober

Bonding





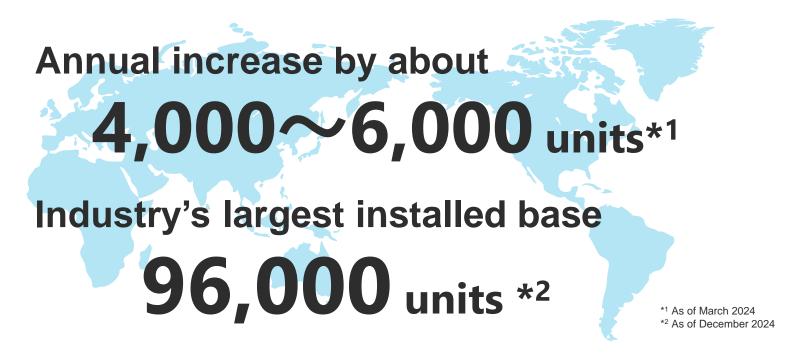




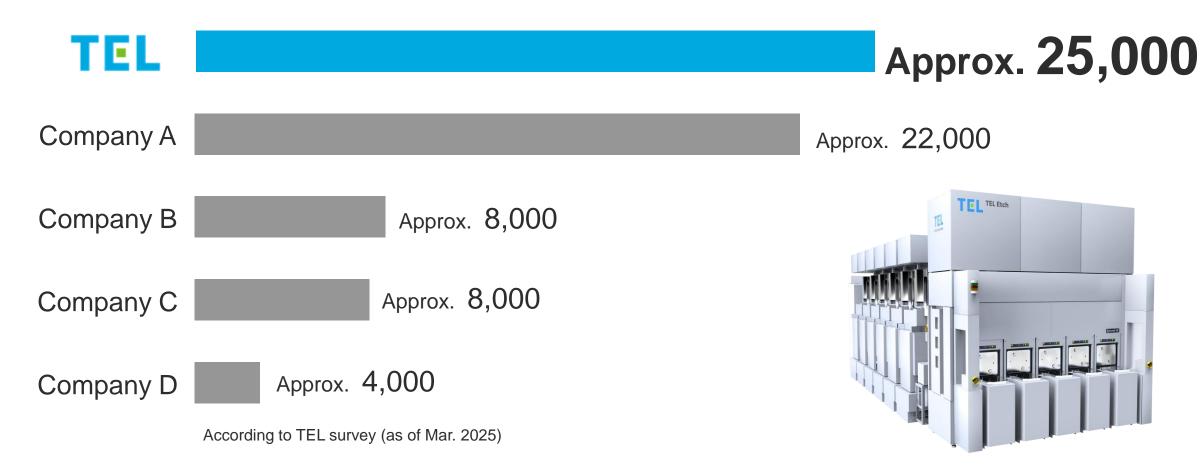


Products with the world's No. 1 or No. 2 market share





The highest number of installations in the industry



The highest number of registered patents in the WFE industry

High Evaluation of TEL's Intellectual Property by External Agencies

Clarivate

Top 100 Global Innovators 2025

Awarded for 4 Consecutive Years

Assess the number, influence, and investment in patents over the five-year period 2019-2023



LexisNexis

Innovation Momentum 2025: The Global Top 100

Awarded for 4 Consecutive Years

Assess Market coverage and Technology relevance over the past two years



Investment For Future Growth (FY2025 to FY2029)

R&D Investment

1.5 trillion yen



Capex

700 billion yen



Recruitment

10,000
people
2,000 people/year



Capital Expenditures









Every leading-edge semiconductor in the world passes through our equipment

Profit is an important measure of value in our products and services

Further improving strengths



3. Aiming for Further Corporate Value Enhancement

Vision

A company
filled with dreams and vitality
that contributes to
technological innovation
in semiconductors.



Innovation

Pursue technological innovation in semiconductors that supports the sustainable development of the world



Profitability

Continuously create high value-added leadingedge equipment and technical services



People

Our corporate growth is enabled by people, and our employees both create and fulfill company values

Stakeholder Engagement

CSV

Creating Shared Value

Creation of social and economic value

TEL's Shared Value

Achieving digitalization and global sustainability

"Technological innovation in semiconductors is essential"



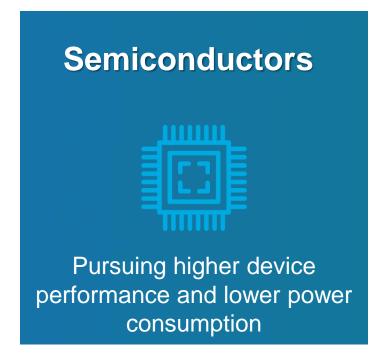


Scope 1&2 : CO₂ Emissions from energy use such as electricity in business activities

Scope 3 : CO₂ Emissions from the use and disposal of sold equipment, material purchases and logistics, etc.

E-COMPASS 🖅

Environmental Co-Creation by Material, Process and Subcomponent Solutions







Promoting technological innovation of semiconductors and reducing environmental impact throughout the supply chain

Our Employees both Create and Fulfill Company Values

Number of New Graduates Entries (Japan)

Employee Retention Rates

25,245 people (For New Graduates in April 2025 : 543 hires)

99.1% Japan

In the last 6 years

Approx. 3 times

(97.6% Global)

Securing and retaining human resources for sustainable growth

Further Increasing Corporate Value

Offence

&

Offence

Aiming for world-class operating margin and ROE ≥ 30%

- Safety
- Quality
- Compliance
- Engagement
- Risk management& Security

4. Returns to Shareholders

Basic Approach for Shareholder Returns

Continuously create high value-added leadingedge equipment and technical services

Aiming for short-, medium- and long-term profits at the same time, and continuous and further corporate value enhancement



Dividend Policy

Dividend payout ratio: 50%

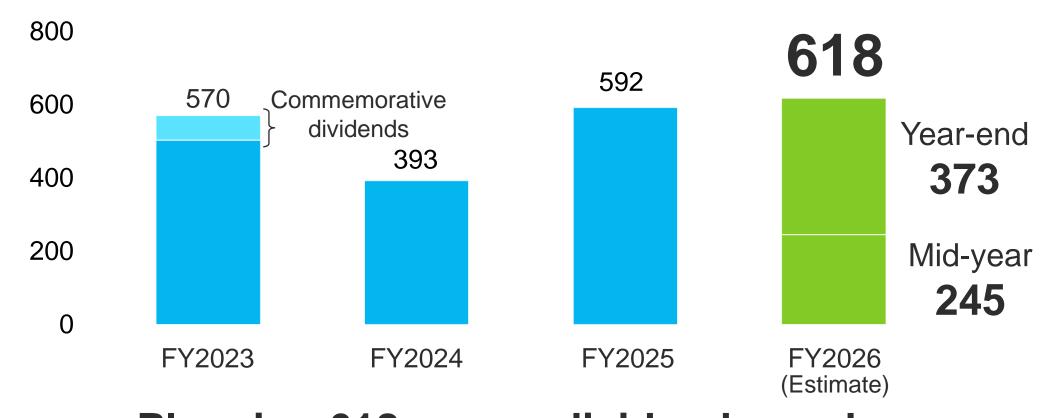
Annual DPS (dividend per share) of no less than 50 yen

Review dividend policy if the company does not generate net income for two consecutive fiscal years.



FY2026 Dividend Forecast

[Annual dividend per share (yen)]



Planning 618 yen as dividend per share

Note: The per share dividend amounts for FY2023 are stated based on the assumption of a stock split at the beginning of FY2023.

We will continue striving to further increase shareholder value and meet the expectations of all stakeholders

